

# **Ultrafast Rectifier, 1 A FRED Pt®**

## **eSMP® Series**


**SMP (DO-220AA)**

Cathode  Anode

## **LINKS TO ADDITIONAL RESOURCES**



## **PRIMARY CHARACTERISTICS**

|                       |                |
|-----------------------|----------------|
| $I_{F(AV)}$           | 1 A            |
| $V_R$                 | 100 V, 200 V   |
| $V_F$ at $I_F$        | 0.69 V         |
| $I_{FSM}$             | 40 A           |
| $t_{rr}$ (typ.)       | 23 ns          |
| $T_J$ max.            | 175 °C         |
| Package               | SMP (DO-220AA) |
| Circuit configuration | Single         |

## **FEATURES**

- Very low profile - typical height of 1.0 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- For PFC, CRM snubber operation
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## **TYPICAL APPLICATION**

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial and automotive applications.

## **MECHANICAL DATA**

**Case:** SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating

**Terminals:** matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

## **ABSOLUTE MAXIMUM RATINGS**

| PARAMETER                                   | SYMBOL         | TEST CONDITIONS                         | VALUES      | UNITS |
|---------------------------------------------|----------------|-----------------------------------------|-------------|-------|
| Peak repetitive reverse voltage             | $V_{RRM}$      |                                         | 100         | V     |
|                                             |                |                                         | 200         |       |
| Average rectified forward current           | $I_{F(AV)}$    | $T_C = 168\text{ °C}$                   | 1           | A     |
| Non-repetitive peak surge current           | $I_{FSM}$      | $T_J = 25\text{ °C}$ , 10 ms sine pulse | 40          |       |
| Operating junction and storage temperatures | $T_J, T_{Stg}$ |                                         | -55 to +175 | °C    |

## **ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)**

| PARAMETER                           | SYMBOL        | TEST CONDITIONS                            | MIN. | TYP. | MAX. | UNITS         |
|-------------------------------------|---------------|--------------------------------------------|------|------|------|---------------|
| Breakdown voltage, blocking voltage | $V_{BR}, V_R$ | $I_R = 100\text{ }\mu\text{A}$             | 100  | -    | -    | V             |
|                                     |               |                                            | 200  | -    | -    |               |
| Forward voltage                     | $V_F$         | $I_F = 1\text{ A}$                         | -    | 0.86 | 0.92 |               |
|                                     |               | $I_F = 1\text{ A}$ , $T_J = 150\text{ °C}$ | -    | 0.69 | 0.74 |               |
| Reverse leakage current             | $I_R$         | $V_R = V_R$ rated                          | -    | -    | 2    | $\mu\text{A}$ |
|                                     |               | $T_J = 150\text{ °C}$ , $V_R = V_R$ rated  | -    | -    | 20   |               |
| Junction capacitance                | $C_T$         | $V_R = 200\text{ V}$                       | -    | 8    | -    | pF            |

| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) |           |                                                                                   |      |      |      |       |
|----------------------------------------------------------------------------------------------------------|-----------|-----------------------------------------------------------------------------------|------|------|------|-------|
| PARAMETER                                                                                                | SYMBOL    | TEST CONDITIONS                                                                   | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time                                                                                    | $t_{rr}$  | $I_F = 1.0\text{ A}$ , $dI_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ | -    | 23   | -    | ns    |
|                                                                                                          |           | $I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$              | -    | -    | 28   |       |
|                                                                                                          |           | $T_J = 25\text{ }^{\circ}\text{C}$                                                | -    | 14   | -    |       |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                               | -    | 22   | -    |       |
| Peak recovery current                                                                                    | $I_{RRM}$ | $T_J = 25\text{ }^{\circ}\text{C}$                                                | -    | 1.7  | -    | A     |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                               | -    | 2.7  | -    |       |
| Reverse recovery charge                                                                                  | $Q_{rr}$  | $T_J = 25\text{ }^{\circ}\text{C}$                                                | -    | 10   | -    | nC    |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                               | -    | 29   | -    |       |

| THERMAL - MECHANICAL SPECIFICATIONS            |              |                                   |                               |      |      |      |       |
|------------------------------------------------|--------------|-----------------------------------|-------------------------------|------|------|------|-------|
| PARAMETER                                      |              | SYMBOL                            | TEST CONDITIONS               | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range |              | T <sub>J</sub> , T <sub>Stg</sub> |                               | -55  | -    | 175  | °C    |
| Thermal resistance, junction mount             |              | R <sub>thJM</sub> <sup>(1)</sup>  | Infinite heatsink             | -    | 7    | 9    | °C/W  |
| Thermal resistance, junction to ambient        |              | R <sub>thJA</sub>                 | PCB footprint 4.8 mm x 4.8 mm | -    | 107  | -    |       |
| Marking device                                 | VS-1ENH01-M3 |                                   | Case style SMP (DO-220AA)     | 1H1  |      |      |       |
|                                                | VS-1ENH02-M3 |                                   |                               | 1H2  |      |      |       |

**Note**

(1) Thermal resistance junction to mount follows JEDEC® 51-14 transient dual interface test method (TDIM)

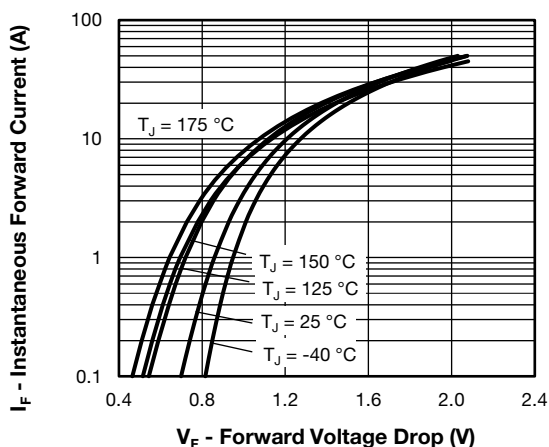


Fig. 1 - Typical Forward Voltage Drop Characteristics

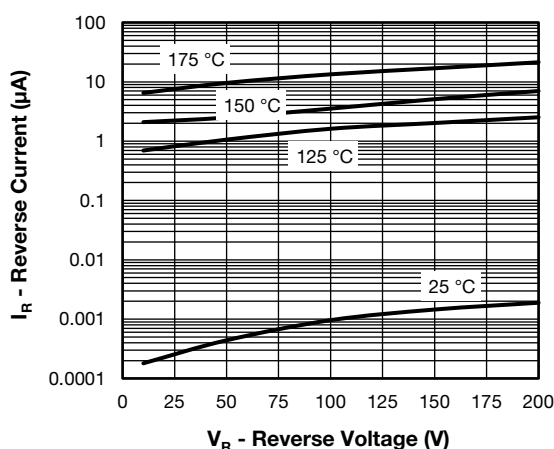


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

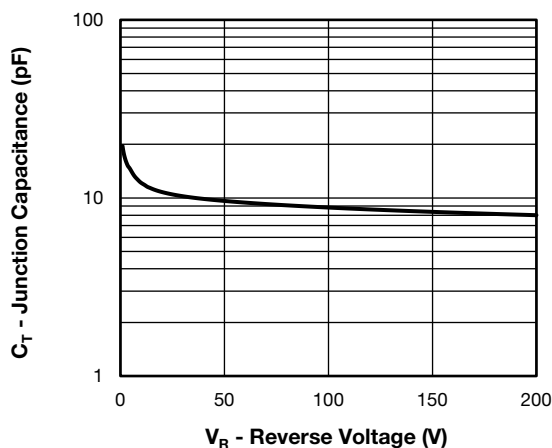


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

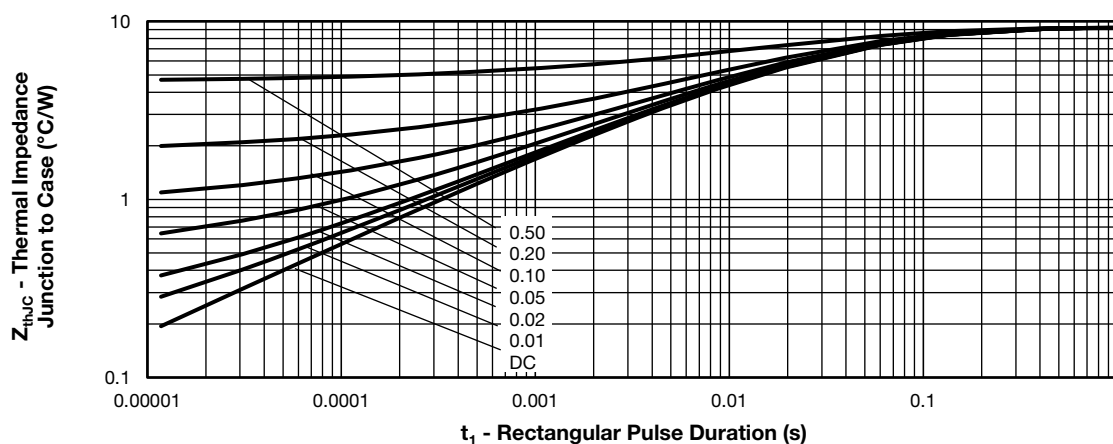


Fig. 4 - Transient Thermal Impedance, Junction to Case

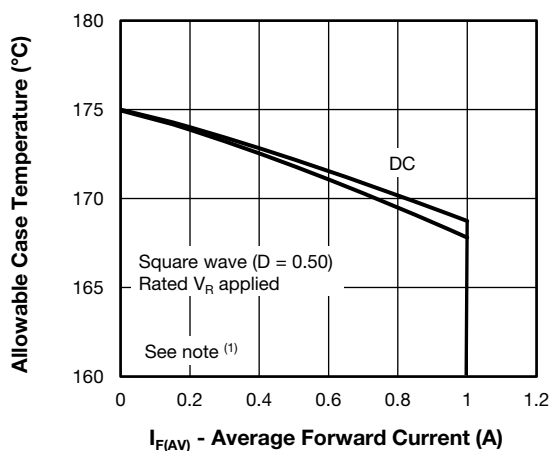


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

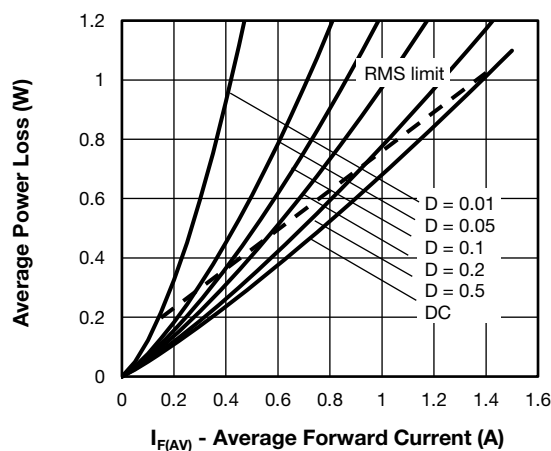


Fig. 6 - Forward Power Loss Characteristics

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$

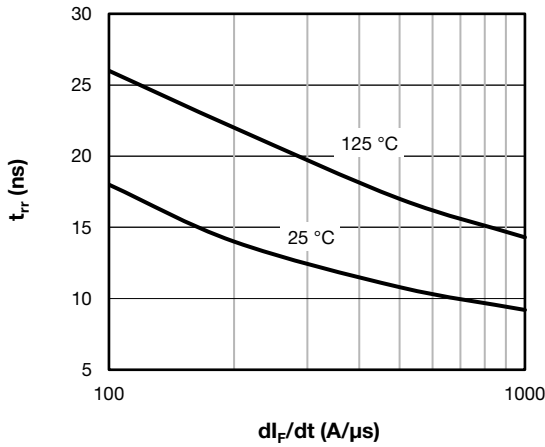
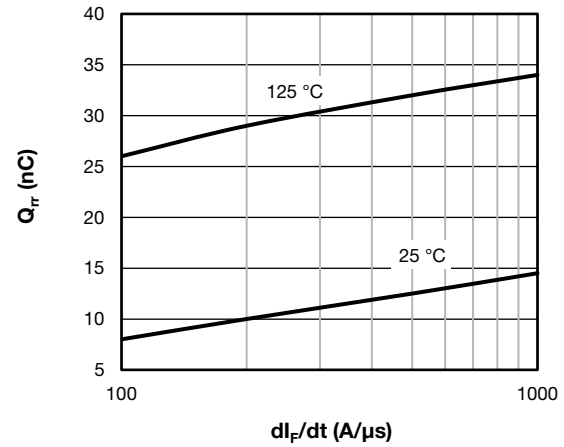
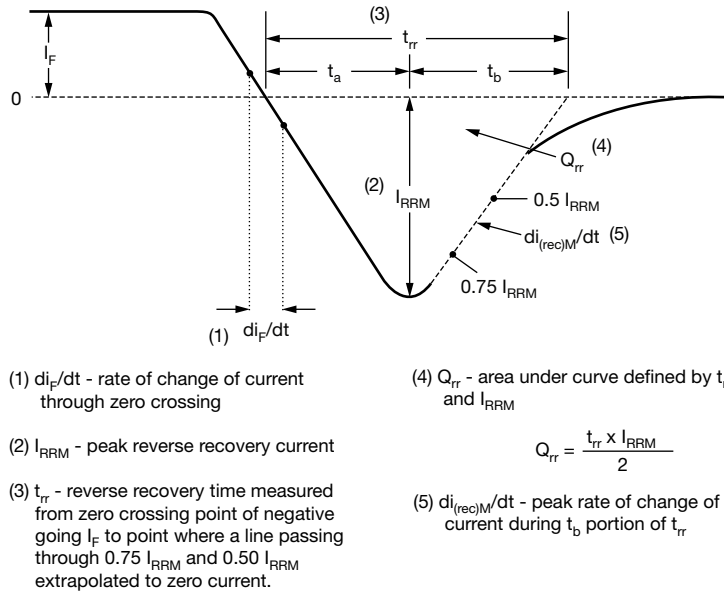

Fig. 7 - Typical Reverse Recovery Time vs.  $di_F/dt$ 

Fig. 8 - Typical Stored Charge vs.  $di_F/dt$ 


Fig. 9 - Reverse Recovery Waveform and Definitions

**ORDERING INFORMATION TABLE**

|             |     |   |                                                                    |   |   |    |    |
|-------------|-----|---|--------------------------------------------------------------------|---|---|----|----|
| Device code | VS- | 1 | E                                                                  | N | H | 02 | M3 |
|             | 1   | 2 | 3                                                                  | 4 | 5 | 6  | 7  |
|             | 1   | - | Vishay Semiconductors product                                      |   |   |    |    |
|             | 2   | - | Current rating (1 = 1 A)                                           |   |   |    |    |
|             | 3   | - | Circuit configuration:                                             |   |   |    |    |
|             |     |   | E = single diode                                                   |   |   |    |    |
|             | 4   | - | N = SMP package                                                    |   |   |    |    |
|             | 5   | - | Process type,                                                      |   |   |    |    |
|             |     |   | H = ultrafast recovery                                             |   |   |    |    |
|             | 6   | - | Voltage code (02 = 200 V)                                          |   |   |    |    |
|             | 7   | - | M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free |   |   |    |    |

**ORDERING INFORMATION** (Example)

| PREFERRED P/N    | PREFERRED PACKAGE CODE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION              |
|------------------|------------------------|------------------------|------------------------------------|
| VS-1ENH01-M3/84A | 84A                    | 3000                   | 7" diameter plastic tape and reel  |
| VS-1ENH01-M3/85A | 85A                    | 10 000                 | 13" diameter plastic tape and reel |
| VS-1ENH02-M3/84A | 84A                    | 3000                   | 7" diameter plastic tape and reel  |
| VS-1ENH02-M3/85A | 85A                    | 10 000                 | 13" diameter plastic tape and reel |

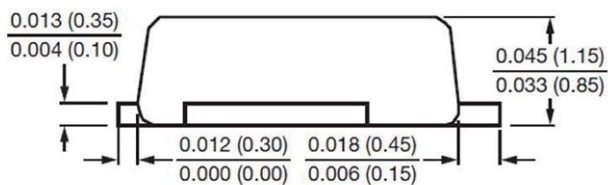
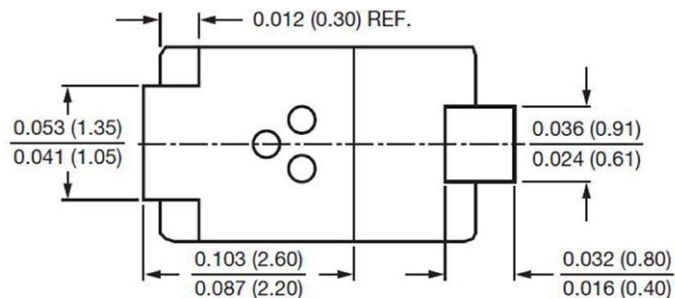
**LINKS TO RELATED DOCUMENTS**

|                          |                                                                        |
|--------------------------|------------------------------------------------------------------------|
| Dimensions               | <a href="http://www.vishay.com/doc?96547">www.vishay.com/doc?96547</a> |
| Part marking information | <a href="http://www.vishay.com/doc?96574">www.vishay.com/doc?96574</a> |
| Packaging information    | <a href="http://www.vishay.com/doc?88869">www.vishay.com/doc?88869</a> |
| SPICE model              | <a href="http://www.vishay.com/doc?96550">www.vishay.com/doc?96550</a> |

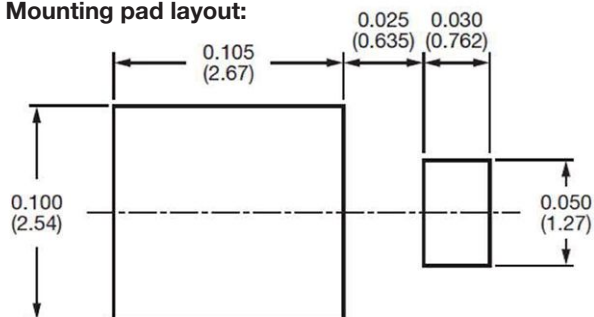


## SMP (DO-220AA)

**DIMENSIONS** in inches (millimeters)



Mounting pad layout:





## Disclaimer

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